Docket No.

215472US0

## IN THE UNIFERSPATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF: Klaus SCHULTES, et al.

SERIAL NO: 10/029,289

1714

FILED:

December 28, 2001

FOR:

PROCESS FOR PREPARING BEAD POLYMERS WITH AN AVERAGE PARTICLE SIZE IN THE RANGE

FROM 1 TO 40 μM, MOULDING COMPOSITIONS COMPRISING BEAD POLYMER, AND MOULDINGS AND

GAU:

PAMA PLASTISOLS

## **INFORMATION DISCLOSURE STATEMENT UNDER 37 CFR 1.97**

COMMISSIONER FOR PATENTS ALEXANDRIA, VIRGINIA 22313 "RECEIVED MAY 2 8 2003

SIR:

Applicant(s) wish to disclose the following information.

**GROUP 1700** 

## REFERENCES

- ☐ The applicant(s) wish to make of record the references listed on the attached form PTO-1449. Copies of the listed references are attached, where required, as are either statements of relevancy or any readily available English translations of pertinent portions of any non-English language references.
- ☐ A check is attached in the amount required under 37 CFR §1.17(p).

#### **RELATED CASES**

- Attached is a list of applicant's pending application(s) or issued patent(s) which may be related to the present application. A copy of the patent(s), together with a copy of the claims and drawings of the pending application(s) is attached along with PTO 1449.
- ☐ A check is attached in the amount required under 37 CFR §1.17(p).

## **CERTIFICATION**

- ☐ Each item of information contained in this information disclosure statement was first cited in a communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this statement.
- □ No item of information contained in this information disclosure statement was cited in a communication from a foreign patent office in a counterpart foreign application or, to the knowledge of the undersigned, having made reasonable inquiry, was known to any individual designated in 37 CFR §1.56(c) more than three months prior to the filing of this statement.

## **DEPOSIT ACCOUNT**

Please charge any additional fees for the papers being filed herewith and for which no check is enclosed herewith, or credit any overpayment to deposit account number 15-0030. A duplicate copy of this sheet is enclosed.

Respectfully submitted,

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Form PTO 1449 (Modified)  U.S. DEPARTMENT OF COMMERCS ATTY DOCKET NO.  215472US0  APPLICANT  LIST OF REFERENCES CITED BY APPLICANT  Klaus SCHULTES, et al.					
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LIST OF REFERENCES CITED BY APPLICANT Klaus SCHULTES, et al.					
FILING DATE GROUP	GROUP				
December 28, 2001 1714	1714				
U.S. PATENT DOCUMENTS					
EXAMINER DOCUMENT DATE NAME CLASS SUB FILING D					
INITIAL NUMBER DATE NAME CLASS IF APPROP	RIATE				
AA 6,355,712 03/12/02 Schultes, et al.					
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OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, etc.)					
AW					
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AY					
AZ Additional References sheet(s)	Additional References sheet(s) attached				
Examiner Date Considered					
*Examiner: Initial if reference is considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.					



# **LIST OF RELATED CASES**

Docket Number	Serial or Patent Number	Filing or <u>Issue Date</u>	Inventor/ Applicant
0583-0409-0	6,355,712	03/12/02	SCHULTES, et al.
212248US0 PCT	09/926,484	11/09/01	MEIER, et al.
215472US0*	10/029,289	12/28/01	SCHULTES, et al.
215473US0	10/029,265	12/28/01	SCHULTES, et al.
231992US0 PCT	10/363,319	03/03/03	SCHULTES, et al.

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<sup>\*</sup>Present Application; listed for information NFO/ltc